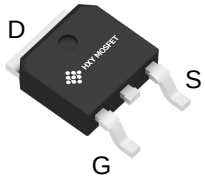
MCU029N10YLHE3-TP

N-Channel Enhancement Mode MOSFET

Description

The MCU029N10YLHE3-TP uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

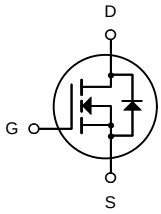


TO-252-2L

General Features

V_{DS}= 100V I_D= 30A

$R_{DS(ON)}$< 30 mΩ@ V_{GS}=10V



N-Channel MOSFET

Application

Battery protection

Load switch

Uninterruptible power supply

Ordering Information

Product ID	Pack	Brand	Qty(PCS)
MCU029N10YLHE3-TP	TO-252-2L	HXY MOSFET	2500

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	±20	V
I_D	Drain Current – Continuous (T_C=25°C)	30	A
	Drain Current – Continuous (T_C=100°C)	20	A
I_{DM}	Drain Current – Pulsed	120	A
EAS	Single Pulse Avalanche Energy	56	mJ
IAS	Single Pulse Avalanche Current	42	A
P_D	Power Dissipation (T_C=25°C)	88	W
	Power Dissipation – Derate above 25°C	0.43	W/°C
T_{STG}	Storage Temperature Range	-55 to 175	°C
T_J	Operating Junction Temperature Range	-55 to 175	°C
$R_{\theta JA}$	Thermal Resistance Junction to ambient	62	°C/W
$R_{\theta JC}$	Thermal Resistance Junction to Case	1.7	°C/W

Electrical Characteristics (T_J=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
BV_{DSS}	Drain-Sourtce Breakdown Voltage	V_{GS}=0V,I_D=250μA	100	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{GS}=0V, V_{DS}=100V	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	V_{GS}=±20V, V_{DS}=0A	---	---	±100	nA
$V_{GS(th)}$	GATE-Source Threshold Voltage	V_{GS}=V_{DS}, I_D=250μA	1	1.5	2.5	V
$R_{DS(ON)}$	Drain-Source On Resistance[2]	V_{GS}=10V,I_D=20A	---	24	30	mΩ
		V_{GS}=4.5V,I_D=10A	---	26	34	mΩ
C_{iss}	Input Capacitance	V_{DS}=25V, V_{GS}=0V, f=1MHz	---	2857	---	pF
C_{oss}	Output Capacitance		---	126	--	
C_{rss}	Reverse Transfer Capacitance		---	99	---	
$t_{d(on)}$	Turn-On Delay Time	V_{DS}=30V, I_D=15A, R_{ENG}=1.8Ω,V_{GS}=10V	---	10	---	ns
t_r	Rise Time		---	44	---	ns
$t_{d(off)}$	Turn-Off Delay Time		---	66	---	ns
t_f	Fall Time		---	47	---	ns
Q_{gs}	Total Gate Charge	V_{GS}=10V, V_{DS}=30V, I_D=15A	---	65	---	nc
Q_{gd}	Gate-Source Charge		---	9	---	nc
Q_g	Gate-Drain “Miller” Charge		---	13	---	nc
V_{SD}	Diode Forward Voltage	V_{GS}=0V, I_{SD}=30A	---	---	1.2	V
I_S	Continuous Drain Curren	VD=VG=0V	---	---	30	A
I_{SM}	Pulsed Drain Current		---	---	120	A
Trr	Reverse Recovery Time	I_F=30A,T_J=25℃ dI/dt=100A/us	---	28	---	ns
Qrr	Reverse Recovery Charge		---	40	---	nc

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
2. EAS condition : T_J=25℃, V_{DD}=50V, V_G=10V, L=0.5mH, Rg=25Ω, I_{AS}=15A
3. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%

Typical Characteristics

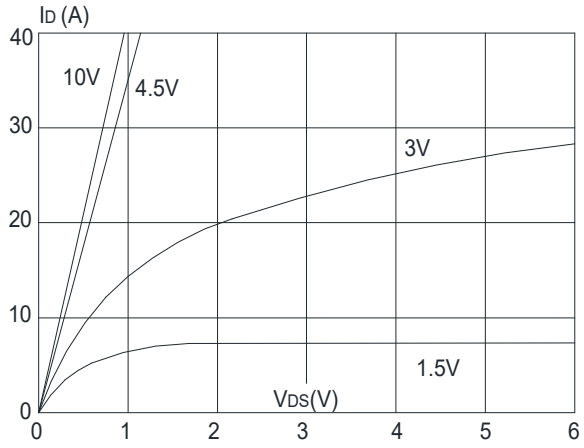


Figure1: Output Characteristics

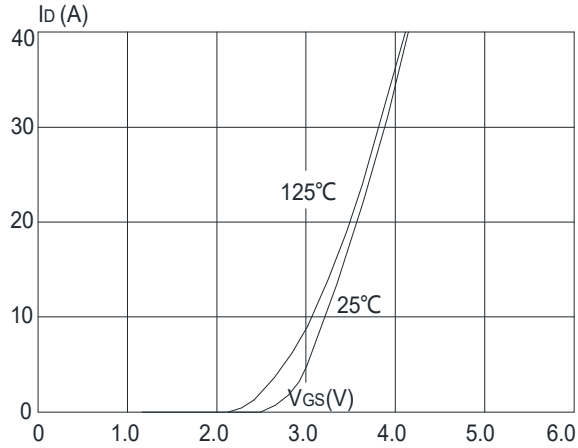


Figure 2: Typical Transfer Characteristics

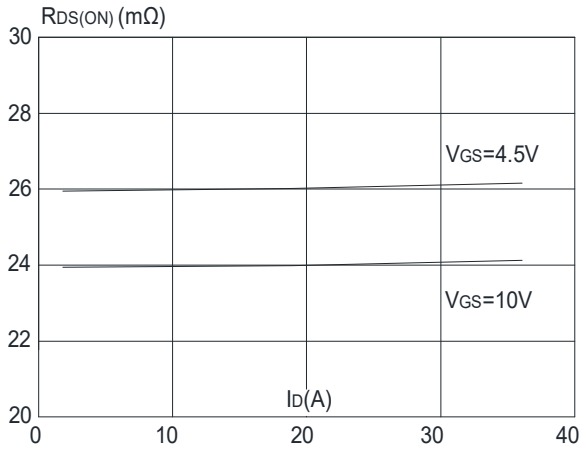


Figure 3: On-resistance vs. Drain Current

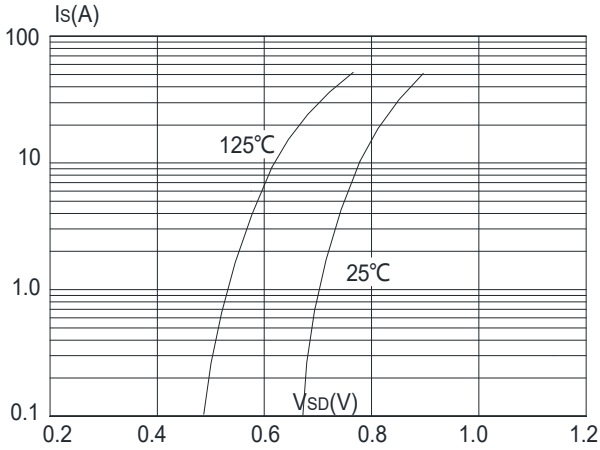


Figure 4: Body Diode Characteristics

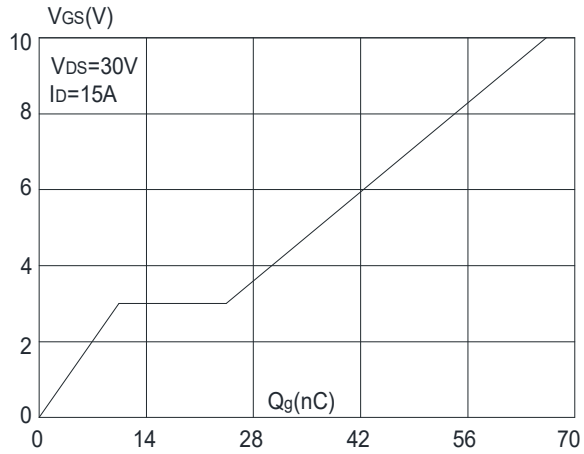


Figure 5: Gate Charge Characteristics

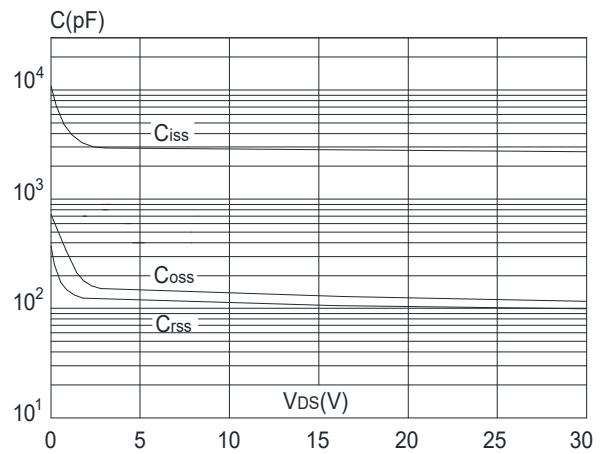


Figure 6: Capacitance Characteristics

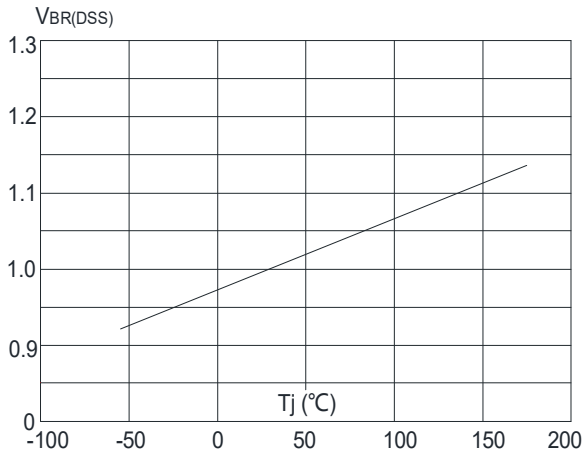


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

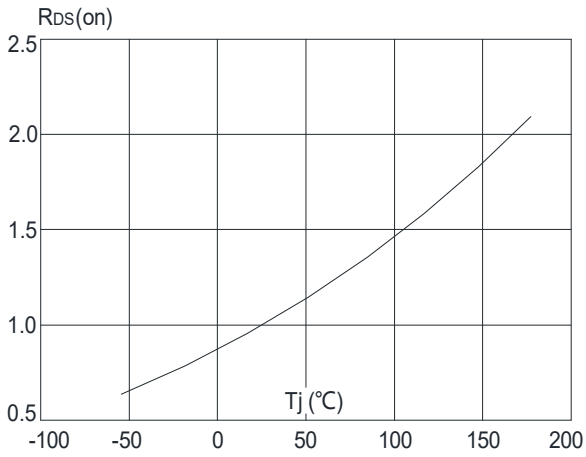


Figure 8: Normalized on Resistance vs. Junction Temperature

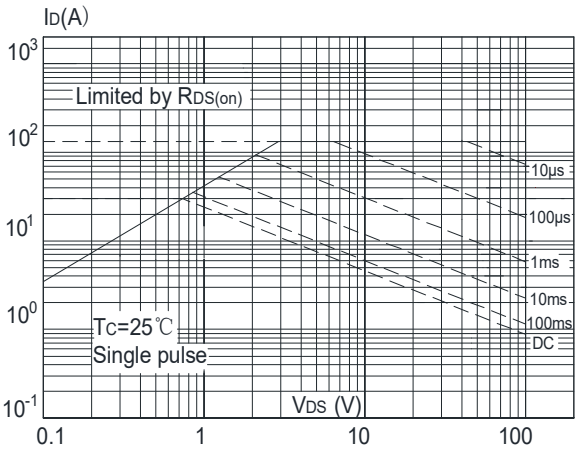


Figure 9: Maximum Safe Operating Area

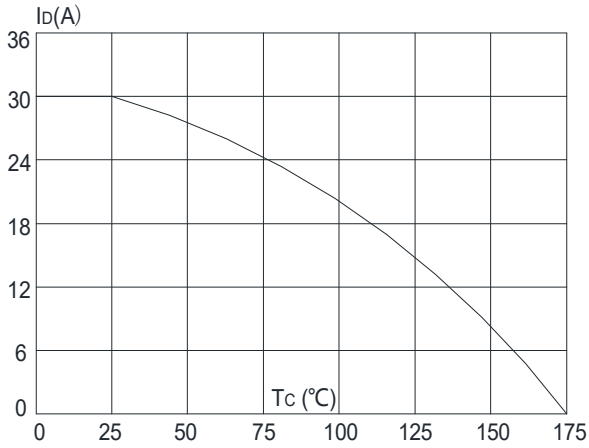


Figure 10: Maximum Continuous Drain Current vs. Case Temperature

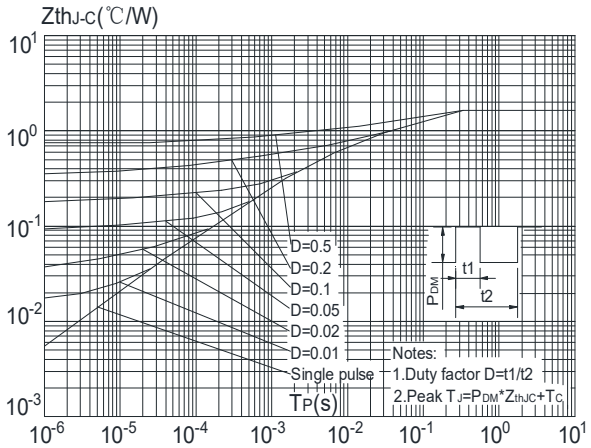
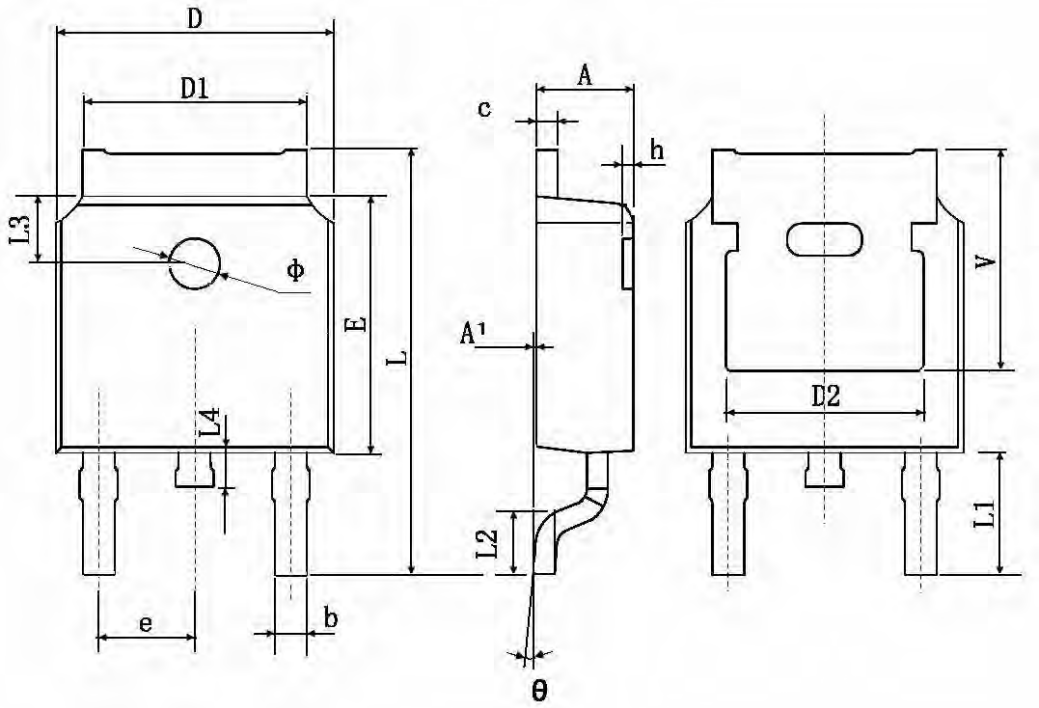


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

TO-252-2L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	0.483 TYP.		0.190 TYP.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600 TYP.		0.063 TYP.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211 TYP.	

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